### PATENT ASSIGNMENT

# Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

## **CONVEYING PARTY DATA**

Name	Execution Date
Yasuyuki SEKIMOTO	06/03/2010

#### **RECEIVING PARTY DATA**

Name:	Murata Manufacturing Co., Ltd.
Street Address:	10-1 Higashikotari 1-chome
City:	Nagaokakyo-shi, Kyoto-fu
State/Country:	JAPAN
Postal Code:	617-8555

### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12813600

### CORRESPONDENCE DATA

Fax Number: (571)313-7421

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: (571) 313-7440

Email: mflorimonte@kbiplaw.com
Correspondent Name: Keating & Bennett LLP
Address Line 1: 1800 Alexander Bell Drive

Address Line 2: Suite 200

Address Line 4: Reston, VIRGINIA 20191

ATTORNEY DOCKET NUMBER:	36856.2062
NAME OF SUBMITTER:	Maura Florimonte

**Total Attachments: 1** 

source=36856-2062-PTO-20100611-Assignment#page1.tif

OF \$40.00 128136

PATENT REEL: 024520 FRAME: 0772

**RECORDED: 06/11/2010** 

P. 02

Attorney Docket No.: 36856.2062

# ASSIGNMENT (WORLDWIDE)

WHEREAS I, Yasuyuki SEKIMOTO (hereinafter referred to as ASSIGNOR),
have invented and own a certain invention entitled METHOD FOR MANUFACTURING
MULTILAYER WIRING SUBSTRATE for which application for Letters Patent of the
United States has been

	executed	on even date	herewith:		
Х	filed on	06-11-10	as Serial No.	12/813,600	

WHEREAS, Murata Manufacturing Co., Ltd., 10-1, Higashikotari 1-chome, Nagaokakyo-shi, Kyoto-fu Japan 617-8555 (hereinafter referred to as ASSIGNEE), is desirous of acquiring the entire interest in, to and under said invention and the United States Letters Patent to be obtained therefor;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration, ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the full and exclusive right, title and interest to the said invention and all Letters Patent of the United States to be obtained therefor on said application or any continuation, division, renewal, substitute or relssue thereof for the full term or terms for which the same may be granted; and all Letters Patent and applications therefor through the world, including all the rights accruling by virtue of the International Convention for the Protection of Industrial Property.

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent as may be known and accessible to ASSIGNOR and will testify as to the same in any interference or litigation related thereto and will promptly execute and deliver to ASSIGNEE or its legal representative any and all papers, instruments or affidavits required to apply for, obtain, maintain and enforce said application, said invention and said Letters Patent which may be necessary or desirable to carry out the purposes hereof.

Dated: June 3, 2010 Yasuyuki SEKIMOTO
Yasuyuki SEKIMOTO

Page 1 of 1

PATENT REEL: 024520 FRAME: 0773